

AM90N10-23P-VB Datasheet N-Channel 100-V (D-S) 175 °C MOSFET

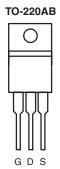
PRODUCT SUMMARY				
V _{DS} (V)	100			
$R_{DS(on)} (\Omega)$ at $V_{GS} = 10 V$	0. 009			
$R_{DS(on)}(\Omega)$ at $V_{GS} = 4.5 V$	0. 020			
I _D (A)	100			
Configuration	Single			

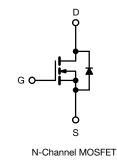
FEATURES

• TrenchFET[®] Power MOSFET



175 °C Maximum Junction Temperature
Compliant to RoHS Directive 2002/95/EC





ABSOLUTE MAXIMUM RATINGS $T_A = 25 \degree C$, unless otherwise noted					
Parameter			Limit	Unit	
Drain-Source Voltage			100	V	
Gate-Source Voltage			± 20	v	
Continuous Drain Current (T _J = 150 °C)	T _C = 25 °C	I _D	100	А	
	T _C = 125 °C	טי	75 ^a		
Pulsed Drain Current	I _{DM}	300	A		
Avalanche Current	L = 0.1 mH	I _{AS}	75		
Single Pulse Avalanche Energy ^b		E _{AS}	280	mJ	
Maximum Power Dissipation ^b	T_{C} = 25 °C (TO-220AB and TO-263)	PD	250 ^c	w	
	T _A = 25 °C (TO-263) ^d	۰D	3.75		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Limit	Unit	
Junction-to-Ambient	PCB Mount (TO-263) ^d	- R _{thJA}	40	°C/W	
Junction-to-Ambient	Free Air (TO-220AB)		62.5		
Junction-to-Case		R _{thJC}	0.6		

Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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SPECIFICATIONS T ₁ = 25 °C	, unless othe	rwise noted				
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static		L		I		<u> </u>
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D = 250 \mu A$	100			
Gate-Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	2		4	- V
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA
		$V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}$			1	μΑ
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} = 100 V, V_{GS} = 0 V, T_{J} = 125 °C			50	
		V_{DS} = 100 V, V_{GS} = 0 V, T_{J} = 175 °C			250	1
On-State Drain Current ^a	I _{D(on)}	$V_{DS} = \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	120			А
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 30 \text{ A}$		0.009		Ω
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 20 \text{ A}$		0.020		
		V_{GS} = 10 V, I _D = 30 A, T _J = 125 °C		0.023		
		V_{GS} = 10 V, I _D = 30 A, T _J = 175 °C		0.030		
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 30 A	25			S
Dynamic ^b						
Input Capacitance	C _{iss}			4700		pF
Output Capacitance	C _{oss}	$V_{GS} = 0 V$, $V_{DS} = 25 V$, f = 1 MHz		665		
Reverse Transfer Capacitance	C _{rss}			265		
Total Gate Charge ^c	Qg			105	160	
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = 50$ V, $V_{GS} = 10$ V, $I_{D} = 85$ A		17		nC
Gate-Drain Charge ^c	Q _{gd}			23		
Turn-On Delay Time ^c	t _{d(on)}			12	25	ns
Rise Time ^c	t _r	V_{DD} = 50 V, R_L = 0.6 Ω		90	135	
Turn-Off DelayTime ^c	t _{d(off)}	$I_D \cong 85$ A, V_{GEN} = 10 V, R_g = 2.5 Ω		55	85	
Fall Time ^c	t _f			130	195	
Source-Drain Diode Ratings and Char	acteristics T _C =	= 25 °C ^b				
Continuous Current	ا _S				85	Α
Pulsed Current	I _{SM}				240	
Forward Voltage ^a	V _{SD}	I _F = 85 A, V _{GS} = 0 V		1.0	1.5	V
Reverse Recovery Time	t _{rr}			85	140	ns
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = 50 A, dl/dt = 100 A/μs		4.5	7	A

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

Q_{rr}

c. Independent of operating temperature.

Reverse Recovery Charge

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μC

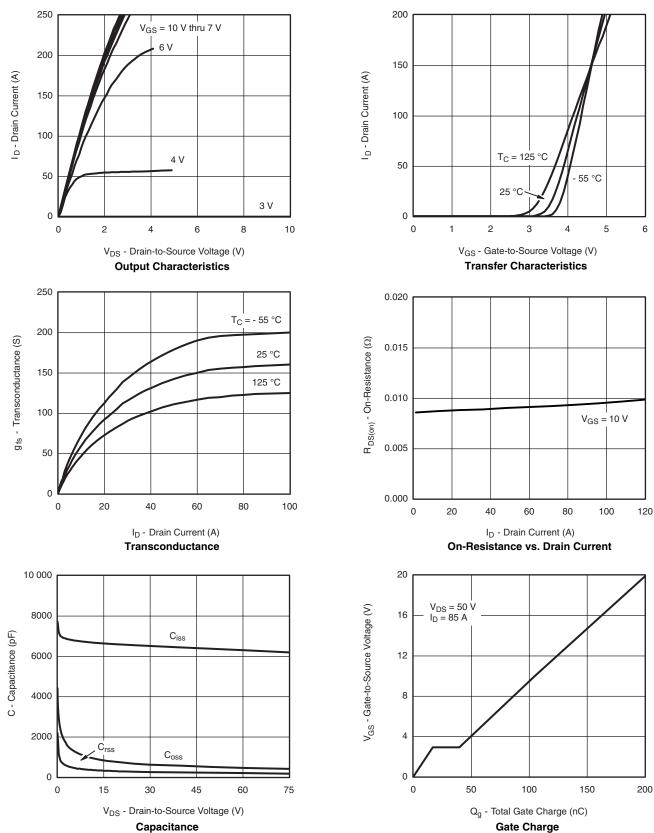
0.17

0.35

Bsemi

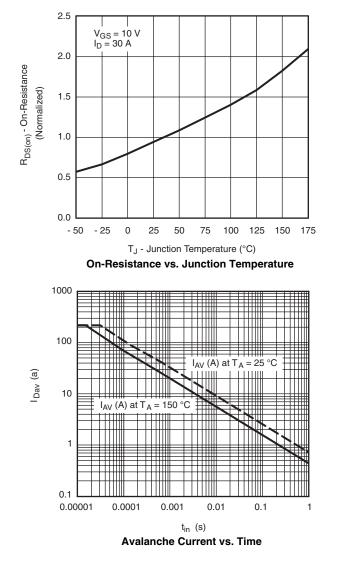


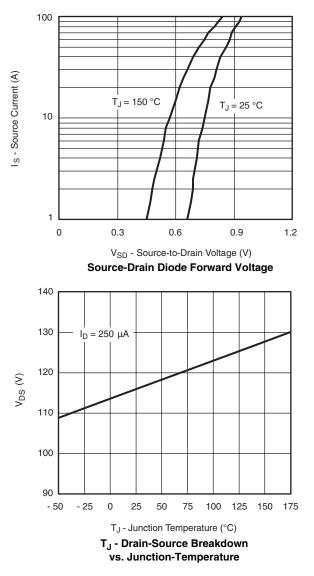
TYPICAL CHARACTERISTICS $T_A = 25 \ ^\circ C$, unless otherwise noted





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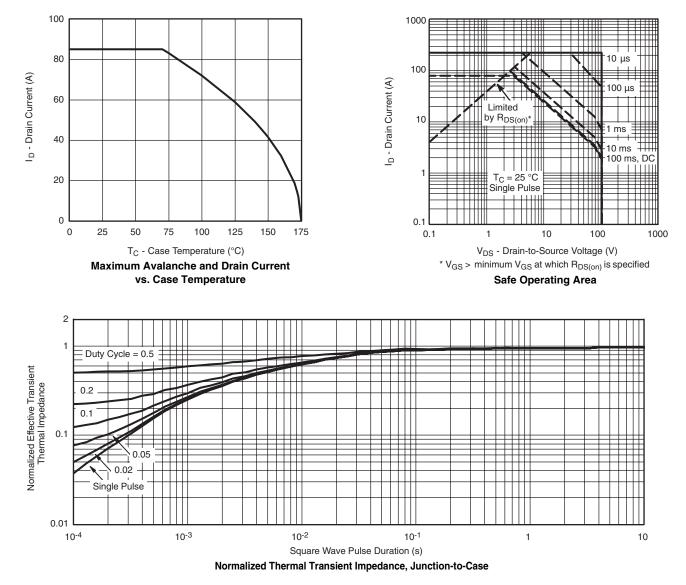




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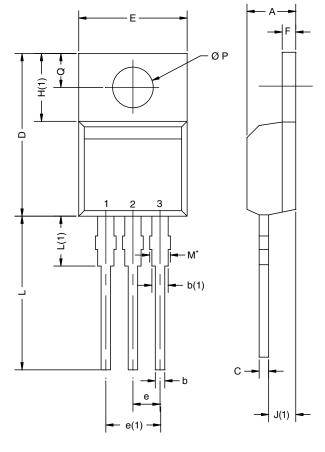


THERMAL RATINGS





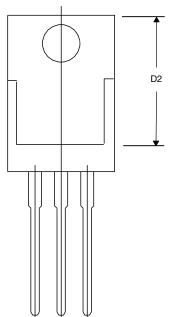
TO-220AB



	MILLIN	IETERS	INC	HES	
DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.25	4.65	0.167	0.183	
b	0.69	1.01	0.027	0.040	
b(1)	1.20	1.73	0.047	0.068	
с	0.36	0.61	0.014	0.024	
D	14.85	15.49	0.585	0.610	
D2	12.19	12.70	0.480	0.500	
E	10.04	10.51	0.395	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.09	6.48	0.240	0.255	
J(1)	2.41	2.92	0.095	0.115	
L	13.35	14.02	0.526	0.552	
L(1)	3.32	3.82	0.131	0.150	
ØР	3.54	3.94	0.139	0.155	
Q	2.60	3.00	0.102	0.118	
ECN: T14-0413-Rev. P, 16-Jun-14 DWG: 5471					

Note

* M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM





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